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| INFORMATION DISCLOSURE<br>STATEMENT BY APPLICANT<br><br>(Use as many sheets as necessary) |   |    |   | Complete if Known    |                     |
|---|---|----|---|----------------------|---------------------|
|   |   |    |   | Application Number   | 10/777,858          |
|   |   |    |   | Filing Date          | 02/12/2004          |
|   |   |    |   | First Named Inventor | W. Denis Markiewicz |
|   |   |    |   | Group Art Unit       | Not yet assigned    |
|   |   |    |   | Examiner Name        | Not yet assigned    |
| Sheet   | 1 | of | 3 | Attorney Docket No.  | FSU 10419.2         |

| U.S. PATENT DOCUMENTS |                          |                      |  |  |  |
|-----------------------|--------------------------|----------------------|--|--|--|
| Examiner<br>Initials* | Cite<br>No. <sup>1</sup> | U.S. Patent Document |  | Name of Patentee or Applicant of<br>Cited Document | Date of Publication of Cited<br>Document<br>MM-DD-YYYY |
|                       |                          | Number               | Kind<br>Code <sup>2</sup><br>(if<br>known) |  |  |
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|-----------------------|--------------------|--------------------|----------|
| Examiner<br>Signature | <i>Bernard Rye</i> | Date<br>Considered | 09/29/05 |
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| OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS |                       |  |                |
|---|-----------------------|--|----------------|
| Examiner Initials*                                | Cite No. <sup>1</sup> | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.                 | T <sup>6</sup> |
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| Examiner Signature | <i>Bernard Rgi</i> | Date Considered | 09/29/05 |
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